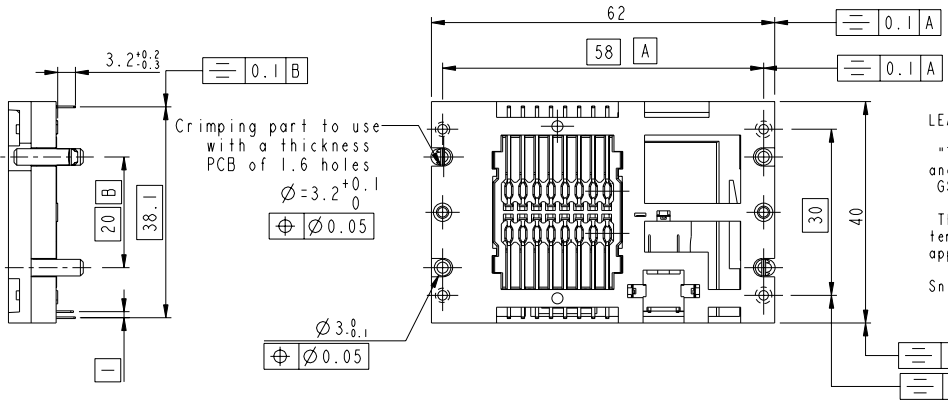
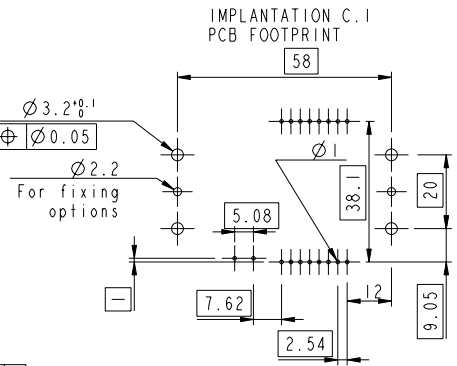
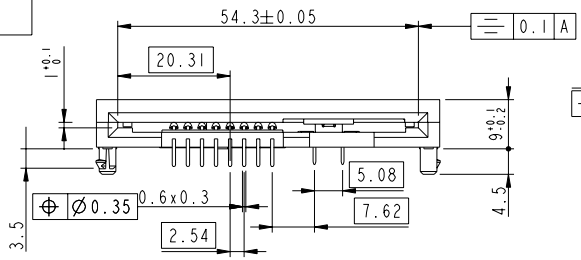


CATALOGUE NUMBER	LEAD FREE VERSION
7434L0835S01	7434L0835S01LF



LEAD FREE VERSION:

"This product meets European Union Directives and other country regulations as described in GS-22-008"

The housing will withstand exposure to 260°C peak temperature for 3-5seconds in a wave solder application with a 1.6mm minimum thick circuit board.

Sn Matte plating on solder tail for Lead Free Versions

Tol Gen: 0mm to 10mm ±0.1mm
 10mm to 30mm ±0.15mm
 30mm to 60mm ±0.2mm
 60mm and above ±0.3mm

rev	ecn no	dr	date
A	F20307	DLE	2002/04/29
B	105-0167	NT	2005/09/26
C	106-0084	SSC	2006/06/21
D	108-0080	SSC	2008/06/28

www.fciconnect.com		surface ISO:1302	tolerance std ISO:406 ISO:1101	projection MM	size A3	Scale 1:1
Dr D.LEGRAND 2002/04/29		TOLERANCES UNLESS OTHERWISE SPECIFIED		ECN 108-0080		
Eng F.TISSERAND 2002/04/29		ANGULAR	LINEAR	Spec ref -		
Chr S.S.CHERIAN 2008/06/28		0.X	0.XX	Product family SMARTCARD		
Appr S.S.CHERIAN 2008/06/28		0.XXX	0.XXX	Title SMARTCARD ASSEMBLY		
FCJ		catalog no SEE TABLE		dwg no VJW12077		Rev. D